



TQFP

Thin Quad Flat Package

DESCRIPTION

TQFP is a quad-sided lead frame based plastic package with body thickness of only 1.0mm. It is available in different body sizes and pin counts from 32L to 128L. The broad pin count range and body size choices of the TQFP make it a very versatile package for wide range of devices from ASIC, gate arrays to memory and mixed signal devices. Its low package profile is well suited for portable and consumer products that demands thin and light components.

The package meets JEDEC Moisture Sensitivity
Level 3 standard that ensures reliability in its
functions.

SPECIFICATIONS

₱ Die Thickness 279um (11mils) maximum

Gold Wire
 99.99% Au

Mold Compound EME G700 (Green)

EME 7372 (Non-Green)

Plating
Matte Tin

Marking
White Ink / Laser Mark

Packing
Tray

APPLICATIONS

- DSP/ Base Band ICs
- Gate Arrays
- Logic/ ASIC
- Micro-controllers/ Micro
- Processors
- Chipsets/ Graphics Chip
- Mixed Signal/ Analog ICs

RELIABILITY

MSL Level: MSL 3 @ 240°C for Sn/Pb

MSL Level: MSL 3 @ 260°C for Pb-Free & Green

Pressure Cook Test: 168hrs (121°C, 100%RH, 2atm)

Temperature Cycling: 500cycles (-65°C/+150°C)

HAST: 100hrs (130°C, 85%RH)

Temperature & Humidity Test: 1,000hrs (85°C, 85%RH)

High Temperature Storage: 1,000hrs (150°C)

FEATURES

- Available body from 7x7mm to 14x14mm
- 32L to 128L lead counts
- Thin body profile (1.0mm)
- JEDEC standard compliant
- JEDEC MSL level 3 qualified for all pin counts

THERMAL PERFORMANCE										
Package Body Size (mm)		Pad Size (mm)	Die Size (mm)	Thermal Performance θ ja (°C/W)						
TQFP 32L	7x7	5.207x5.207	2.57x2.84	48.43						
TQFP 128L	14x14	6x6	3.009x3.074	36.31						

Note: Simulated with JEDEC Standard 4-layer test board under still air condition, ambient temperature 45°C

ELECTRICAL PERFORMANCE										
Package	Body Size (mm)	Pad Size (mm)	Frequency (MHz)	Self Inductance (nH)	Self Capacitance (pF)	Resistance (mohm)				
TQFP 32L	7x7	5.207x5.207	100	2.325~3.323	0.391~0.448	86.53~210.8				
TQFP 128L	14x14	6x6	100	4.962~6.839	0.812~1.034	141.9~331.6				

Note: Results are simulated. Data is available through 2.5 GHz.

CROSS-SECTION

